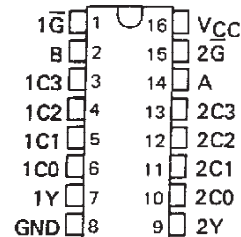# SN54153, SN54LS153, SN54S153
SN74153, SN74LS153, SN74S153
DUAL 4-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

SDLS055A – DECEMBER 1972 – REVISED MAY 2007

- Permits Multiplexing from N lines to 1 line
- Performs Parallel-to-Serial Conversion
- Strobe (Enable) Line Provided for Cascading (N lines to n lines)
- High-Fan-Out, Low-Impedance, Totem-Pole Outputs
- Fully Compatible with most TTL Circuits

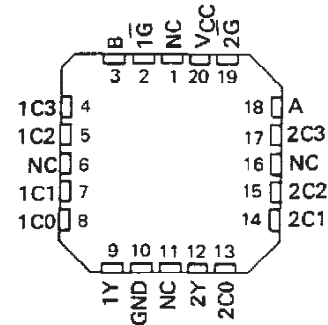| TYPE	TYPICAL AVERAGE PROPAGATION DELAY TIMES			TYPICAL POWER DISSIPATION
	FROM DATA	FROM STROBE	FROM SELECT	
'153	14 ns	17 ns	22 ns	180 mW
'LS153	14 ns	19 ns	22 ns	31 mW
'S153	6 ns	9.5 ns	12 ns	225 mW

description

Each of these monolithic, data selectors/multiplexers contains inverters and drivers to supply fully complementary, on-chip, binary decoding data selection to the AND-OR gates. Separate strobe inputs are provided for each of the two four-line sections.

FUNCTION TABLE

SELECT INPUTS		DATA INPUTS				STROBE	OUTPUT
B	A	C0	C1	C2	C3	$\overline{G}$	Y
X	X	X	X	X	X	H	L
L	L	L	X	X	X	L	L
L	L	H	X	X	X	L	H
L	H	X	L	X	X	L	L
L	H	X	H	X	X	L	H
H	L	X	X	L	X	L	L
H	L	X	X	H	X	L	H
H	H	X	X	X	L	L	L
H	H	X	X	X	H	L	H

Select inputs A and B are common to both sections.
H = high level, L = low level, X = irrelevant

SN54153, SN54LS153, SN54S153 . . . J OR W PACKAGE[1]
SN74153 . . . N PACKAGE
SN74LS153, SN74S153 . . . D OR N PACKAGE
(TOP VIEW)

$1\overline{G}$	1	16	V_{CC}
B	2	15	2G
1C3	3	14	A
1C2	4	13	2C3
1C1	5	12	2C2
1C0	6	11	2C1
1Y	7	10	2C0
GND	8	9	2Y

SN54LS153, SN54S153 . . . FK PACKAGE [1]
(TOP VIEW)

Pins (top): B, $1\overline{G}$, NC, V_{CC}, 2G — 3 2 1 20 19

1C3	4	18	A
1C2	5	17	2C3
NC	6	16	NC
1C1	7	15	2C2
1C0	8	14	2C1

Pins (bottom): 9 10 11 12 13 — 1Y, GND, NC, 2Y, 2C0

NC – No internal connection

(1) SN54S153, SN74153, and SN74S153 are obsolete.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (See Note 1) . . . . 7 V
Input voltage: '153, 'S153 . . . . 5.5 V
'LS153 . . . . 7 V
Operating free-air temperature range: SN54' . . . . −55°C to 125°C
SN74' . . . . 0°C to 70°C
Storage temperature range . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

logic symbol†

A (14)
0
B (2)   1   G 0/3

1G̅ (1)   EN   MUX
1C0 (6)   0
1C1 (5)   1
1C2 (4)   2
1C3 (3)   3

(7) 1Y

2G̅ (15)
2C0 (10)
2C1 (11)
2C2 (12)
2C3 (13)

(9) 2Y
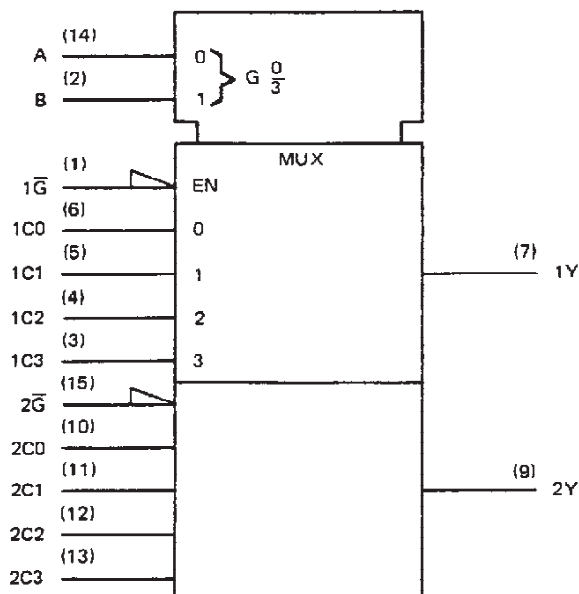
†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC
  Publication 617-12.

logic diagrams (positive logic)

STROBE 1G̅
(ENABLE) (1)
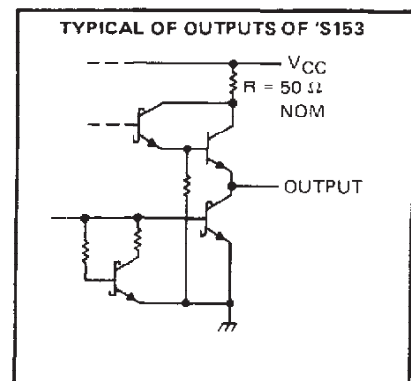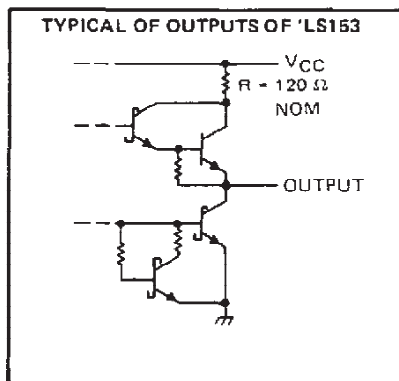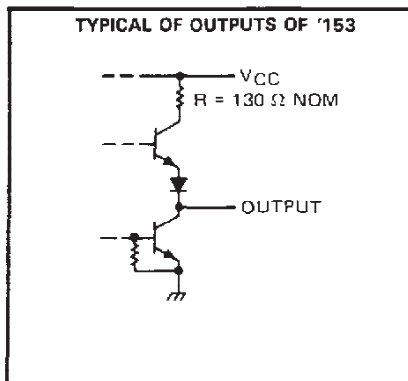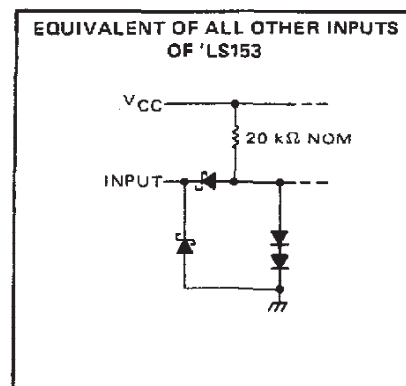1C0 (6)
1C1 (5)
DATA 1
1C2 (4)
1C3 (3)

(7) OUTPUT
1Y

B (2)
SELECT
A (14)

2C0 (10)
2C1 (11)
DATA 2
2C2 (12)
2C3 (13)
STROBE 2G̅
(ENABLE) (15)

(9) OUTPUT
2Y

Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs

EQUIVALENT OF INPUTS OF '153

V_{CC}

4 kΩ NOM

INPUT

EQUIVALENT OF INPUTS OF 'S153

V_{CC}

2.8 kΩ NOM

INPUT

EQUIVALENT OF 1G̅, 2G̅ INPUTS
OF LS153

V_{CC}

10 kΩ NOM

INPUT

EQUIVALENT OF ALL OTHER INPUTS
OF 'LS153

V_{CC}

20 kΩ NOM

INPUT

TYPICAL OF OUTPUTS OF '153

V_{CC}

R = 130 Ω NOM

OUTPUT

TYPICAL OF OUTPUTS OF 'LS153

V_{CC}

R = 120 Ω
NOM

OUTPUT

TYPICAL OF OUTPUTS OF 'S153

V_{CC}

R = 50 Ω
NOM

OUTPUT
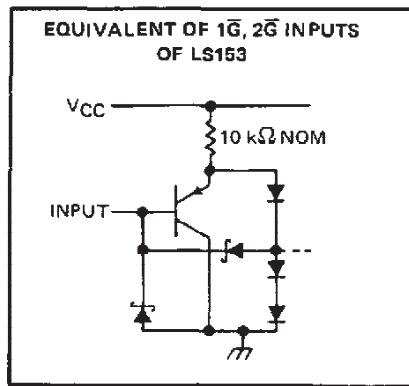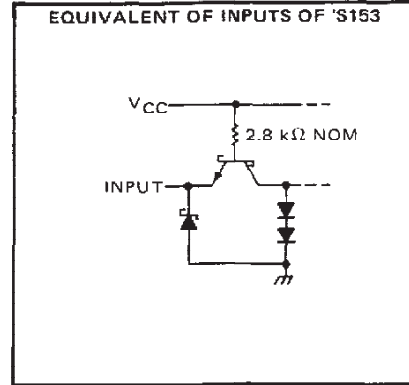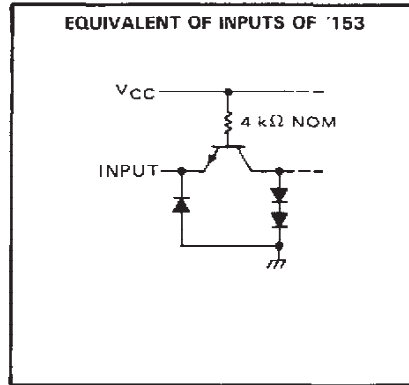
SN54153, SN74153
DUAL 4-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

recommended operating conditions

	SN54153			SN74153			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−800			−800	μA
Low-level output current, I_{OL}			16			16	mA
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS[†]	SN54153			SN74153			UNIT
			MIN	TYP[‡]	MAX	MIN	TYP[‡]	MAX	
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.8			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −12 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −800 μA	2.4	3.4		2.4	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
I_{OS}	Short-circuit output current[§]	V_{CC} = MAX	−20		−55	−18		−57	mA
I_{CCL}	Supply current, output low	V_{CC} = MAX, See Note 2		36	52		36	60	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.
[§]Not more than one output should be shorted at a time.
NOTE 2: I_{CCL} is measured with the outputs open and all inputs grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER[¶]	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Data	Y			12	18	ns
t_{PHL}	Data	Y			15	23	ns
t_{PLH}	Select	Y	C_L = 30 pF, R_L = 400 Ω,		22	34	ns
t_{PHL}	Select	Y	See Note 3		22	34	ns
t_{PLH}	Strobe $\bar{G}$	Y			19	30	ns
t_{PHL}	Strobe $\bar{G}$	Y			15	23	ns

[¶]t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

		SN54LS153			SN74LS153			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
I_{OH}	High-level output current			−0.4			−0.4	mA
I_{OL}	Low-level output current			4			8	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		SN54LS153			SN74LS153			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}		V_{CC} = MIN,	I_I = −18 mA			−1.5			−1.5	V
V_{OH}		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = MAX I_{OH} = −0.4 mA		2.5	3.4		2.7	3.4		V
V_{OL}		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = MAX,	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
			I_{OL} = 8 mA					0.35	0.5	
I_I		V_{CC} = MAX,	V_I = 7 V			0.1			0.1	mA
I_{IH}		V_{CC} = MAX,	V_I = 2.7 V			20			20	μA
I_{IL}	1G, 2G	V_{CC} = MAX,	V_I = 0.4 V			−0.2			−0.2	mA
	All other					−0.4			−0.4	
I_{OS}§		V_{CC} = MAX		−20		−100	−20		−100	mA
I_{CCL}		V_{CC} = MAX,	See Note 2		6.2	10		6.2	10	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.
NOTE 2: I_{CCL} is measured with the outputs open and all inputs grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Data	Y	C_L = 15 pF, R_L = 2 kΩ, See Note 3		10	15	ns
t_{PHL}	Data	Y			17	26	ns
t_{PLH}	Select	Y			19	29	ns
t_{PHL}	Select	Y			25	38	ns
t_{PLH}	Strobe $\overline{G}$	Y			16	24	ns
t_{PHL}	Strobe $\overline{G}$	Y			21	32	ns

¶ t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

	SN54S153			SN74S153			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−1			−1	mA
Low-level output current, I_{OL}			20			20	mA
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS[†]		MIN	TYP[‡]	MAX	UNIT
V_{IH}	High-level input voltage			2			V
V_{IL}	Low-level input voltage					0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −18 mA				−1.2	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V,	Series 54S	2.5	3.4		V
		V_{IL} = 0.8 V, I_{OH} = −1 mA	Series 74S	2.7	3.4		
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 20 mA				0.5	V
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 5.5 V				1	mA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.7 V				50	µA
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.5 V				−2	mA
I_{OS}	Short-circuit output current[§]	V_{CC} = MAX		−40		−100	mA
I_{CCL}	Supply current, low-level output	V_{CC} = MAX, See Note 2			45	70	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.
[§] Not more than one output should be shorted at a time and duration of short-circuit should not exceed one second.
NOTE 2: I_{CCL} is measured with the outputs open and all inputs grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER[¶]	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Data	Y			6	9	ns
t_{PHL}	Data	Y			6	9	ns
t_{PLH}	Select	Y	C_L = 15 pF, R_L = 280 Ω,		11.5	18	ns
t_{PHL}	Select	Y	See Note 3		12	18	ns
t_{PLH}	Strobe $\overline{G}$	Y			10	15	ns
t_{PHL}	Strobe $\overline{G}$	Y			9	13.5	ns

[¶] t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
76011012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	76011012A SNJ54LS 153FK	Samples
7601101EA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601101EA SNJ54LS153J	Samples
7601101FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601101FA SNJ54LS153W	Samples
JM38510/30902BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30902BEA	Samples
M38510/30902BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30902BEA	Samples
SN54153J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54153J	Samples
SN54LS153J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS153J	Samples
SN74LS153D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS153	Samples
SN74LS153DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS153	Samples
SN74LS153DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS153	Samples
SN74LS153N	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS153N	Samples
SN74LS153NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS153	Samples
SNJ54153J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54153J	Samples
SNJ54LS153FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	76011012A SNJ54LS 153FK	Samples
SNJ54LS153J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601101EA SNJ54LS153J	Samples
SNJ54LS153W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601101FA SNJ54LS153W	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

[3] MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

[4] There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

[5] Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

[6] Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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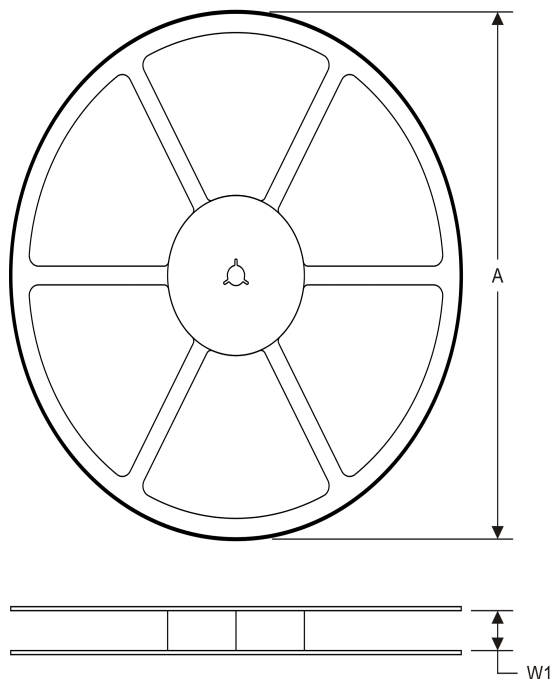**OTHER QUALIFIED VERSIONS OF SN54LS153, SN74LS153 :**

● Catalog: SN74LS153

● Military: SN54LS153

NOTE: Qualified Version Definitions:

● Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

TEXAS INSTRUMENTS

TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS153DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS153NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS153DR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS153NSR	SO	NS	16	2000	367.0	367.0	38.0

FK (S−CQCC−N**)　　　　　　　　LEADLESS CERAMIC CHIP CARRIER
28 TERMINAL SHOWN

NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)

B SQ

A SQ

$\dfrac{0.020\ (0,51)}{0.010\ (0,25)}$

$\dfrac{0.020\ (0,51)}{0.010\ (0,25)}$

$\dfrac{0.080\ (2,03)}{0.064\ (1,63)}$

$\dfrac{0.055\ (1,40)}{0.045\ (1,14)}$

$\dfrac{0.045\ (1,14)}{0.035\ (0,89)}$

$\dfrac{0.028\ (0,71)}{0.022\ (0,54)}$

0.050 (1,27)

$\dfrac{0.045\ (1,14)}{0.035\ (0,89)}$
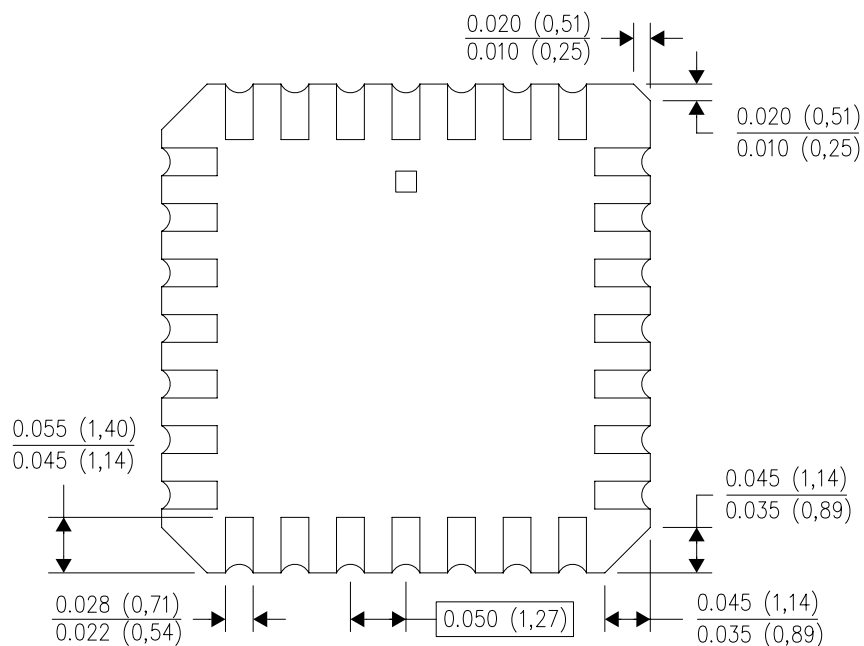
4040140/D 01/11

NOTES:　A.　All linear dimensions are in inches (millimeters).
　　　　B.　This drawing is subject to change without notice.
　　　　C.　This package can be hermetically sealed with a metal lid.
　　　　D.　Falls within JEDEC MS−004

D (R−PDSO−G16)   PLASTIC SMALL OUTLINE
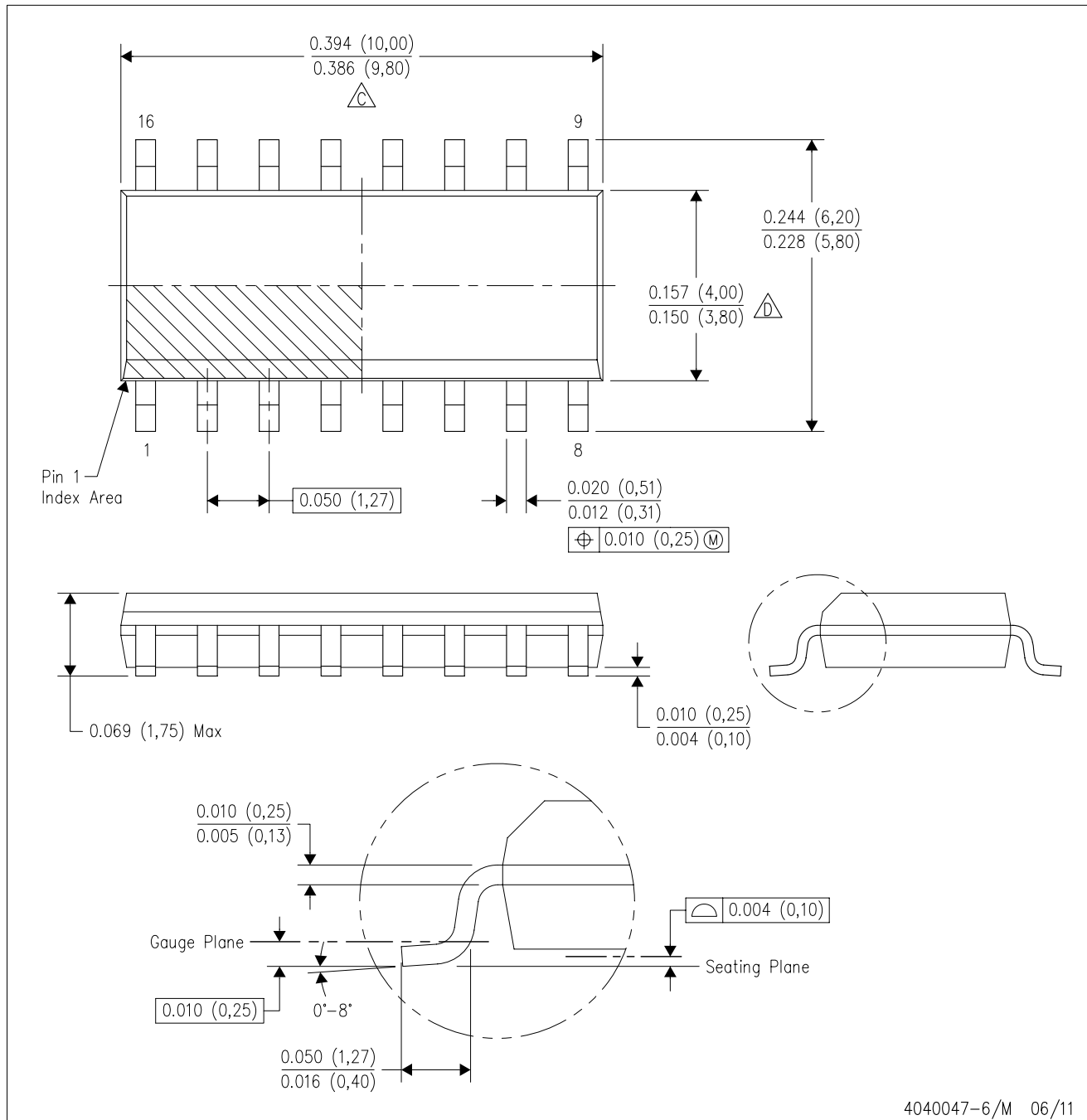
0.394 (10,00)
0.386 (9,80)
/C\

16   9

0.244 (6,20)
0.228 (5,80)

0.157 (4,00)
0.150 (3,80) /D\

1   8

Pin 1
Index Area

0.050 (1,27)

0.020 (0,51)
0.012 (0,31)

⊕ 0.010 (0,25) Ⓜ

0.069 (1,75) Max

0.010 (0,25)
0.004 (0,10)

0.010 (0,25)
0.005 (0,13)

0.004 (0,10)

Gauge Plane

Seating Plane

0.010 (0,25)   0°−8°

0.050 (1,27)
0.016 (0,40)

4040047−6/M   06/11

NOTES: A. All linear dimensions are in inches (millimeters).
          B. This drawing is subject to change without notice.
        /C\ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall
              not exceed 0.006 (0,15) each side.
        /D\ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
          E. Reference JEDEC MS−012 variation AC.
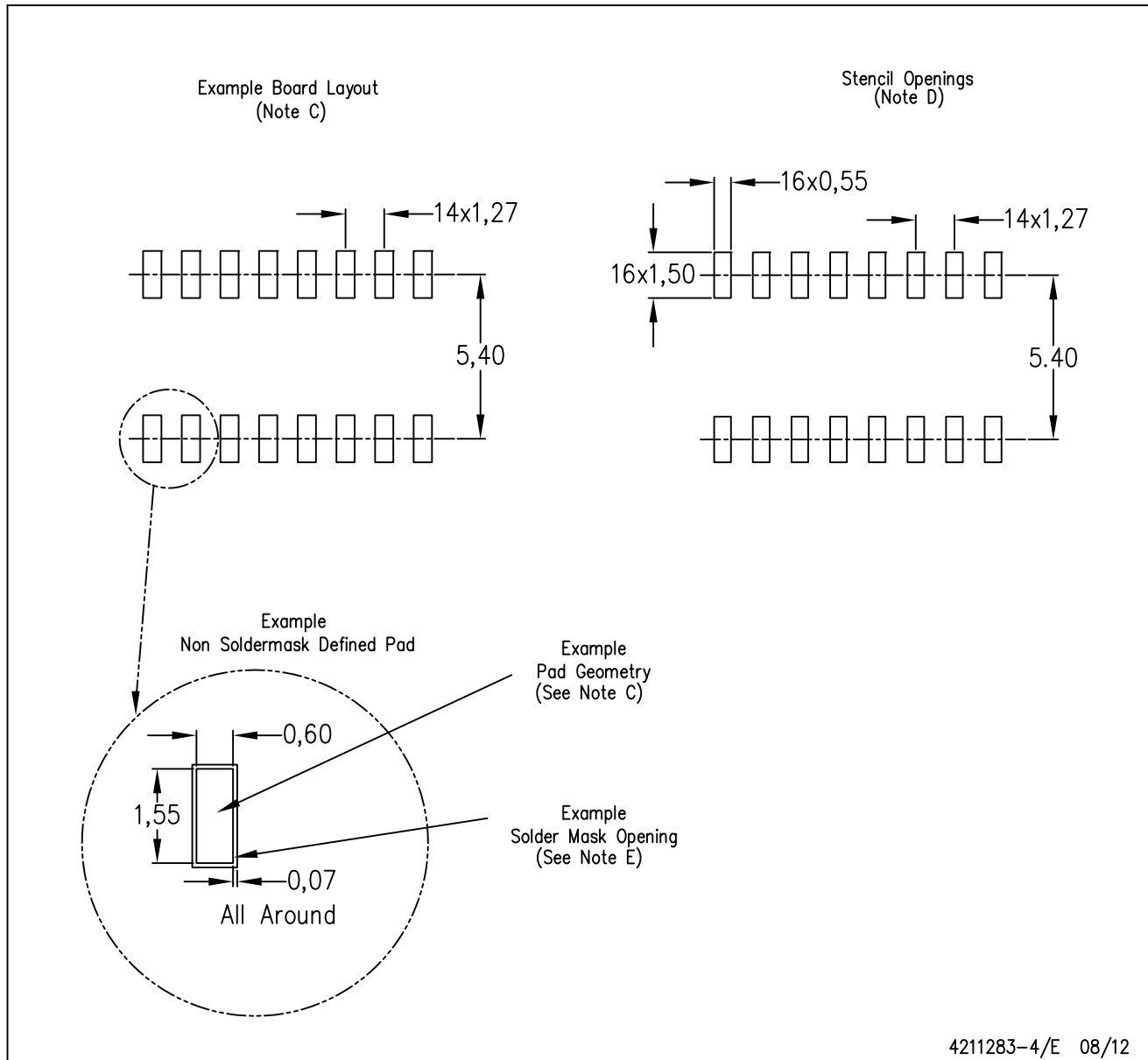
TEXAS INSTRUMENTS
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D (R−PDSO−G16)   PLASTIC SMALL OUTLINE

Example Board Layout
(Note C)

Stencil Openings
(Note D)

←14x1,27

16x0,55

←14x1,27

16x1,50

5,40

5.40

Example
Non Soldermask Defined Pad

Example
Pad Geometry
(See Note C)

←0,60

1,55

Example
Solder Mask Opening
(See Note E)

←0,07

All Around

4211283−4/E 08/12

NOTES: A.   All linear dimensions are in millimeters.
          B.   This drawing is subject to change without notice.
          C.   Publication IPC−7351 is recommended for alternate designs.
          D.   Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should
               contact their board assembly site for stencil design recommendations. Refer to IPC−7525 for other stencil recommendations.
          E.   Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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MECHANICAL DATA

DIM	PINS ** 14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

NOTES: A.   All linear dimensions are in millimeters.
         B.   This drawing is subject to change without notice.
         C.   Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

W (R–GDFP–F16)   CERAMIC DUAL FLATPACK
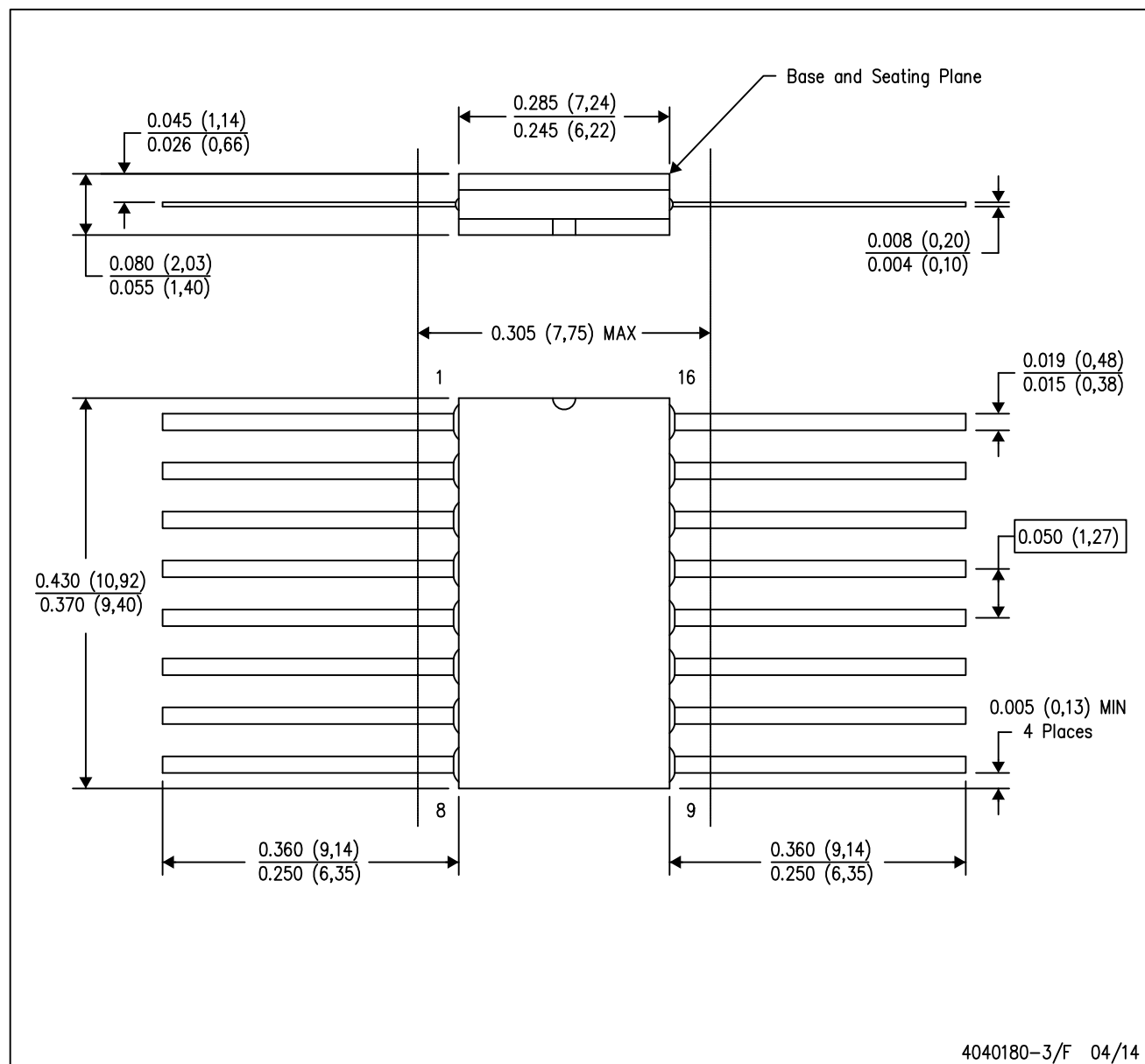
Base and Seating Plane

0.285 (7,24)
0.245 (6,22)

0.045 (1,14)
0.026 (0,66)

0.008 (0,20)
0.004 (0,10)

0.080 (2,03)
0.055 (1,40)

0.305 (7,75) MAX

1   16

0.019 (0,48)
0.015 (0,38)

0.430 (10,92)
0.370 (9,40)

0.050 (1,27)

0.005 (0,13) MIN
4 Places

8   9

0.360 (9,14)
0.250 (6,35)

0.360 (9,14)
0.250 (6,35)

4040180–3/F 04/14

NOTES: A.   All linear dimensions are in inches (millimeters).
         B.   This drawing is subject to change without notice.
         C.   This package can be hermetically sealed with a ceramic lid using glass frit.
         D.   Index point is provided on cap for terminal identification only.
         E.   Falls within MIL STD 1835 GDFP2–F16

J (R−GDIP−T**)   CERAMIC DUAL IN−LINE PACKAGE
14 LEADS SHOWN

0.065 (1,65)
0.045 (1,14)
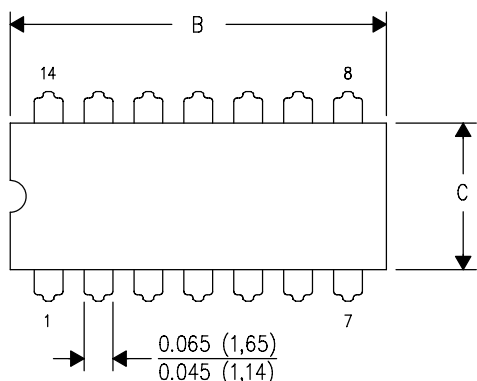
DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	——	——	——	——
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

0.005 (0,13) MIN

0.060 (1,52)
0.015 (0,38)

0.200 (5,08) MAX

Seating Plane

0.130 (3,30) MIN

0.026 (0,66)
0.014 (0,36)

0.100 (2,54)

A

0°−15°

0.014 (0,36)
0.008 (0,20)

4040083/F 03/03

NOTES: A.   All linear dimensions are in inches (millimeters).
         B.   This drawing is subject to change without notice.
         C.   This package is hermetically sealed with a ceramic lid using glass frit.
         D.   Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
         E.   Falls within MIL STD 1835 GDIP1−T14, GDIP1−T16, GDIP1−T18 and GDIP1−T20.

N (R−PDIP−T**)
16 PINS SHOWN

PLASTIC DUAL−IN−LINE PACKAGE

PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS−001 VARIATION	AA	BB	AC	AD

A

16   9

0.260 (6,60)
0.240 (6,10)

1   8

0.070 (1,78)
0.045 (1,14) △D

0.045 (1,14)
0.030 (0,76) △D

0.020 (0,51) MIN

0.325 (8,26)
0.300 (7,62)

0.015 (0,38)

Gauge Plane

0.200 (5,08) MAX

Seating Plane

0.010 (0,25) NOM

0.125 (3,18) MIN

0.100 (2,54)

0.021 (0,53)
0.015 (0,38)

⊕ 0.010 (0,25) Ⓜ

0.430 (10,92) MAX

14/18 Pin Only
20 Pin vendor option △D

4040049/E 12/2002

NOTES: A.   All linear dimensions are in inches (millimeters).
          B.   This drawing is subject to change without notice.
      △C   Falls within JEDEC MS−001, except 18 and 20 pin minimum body length (Dim A).
      △D   The 20 pin end lead shoulder width is a vendor option, either half or full width.